

74HC2G125; 74HCT2G125

Dual buffer/line drivers; 3-state

Rev. 03 — 02 January 2006

Product data sheet

1. General description

The 74HC2G125; 74HCT2G125 is a high-speed, Si-gate CMOS device.

The 74HC2G125; 74HCT2G125 provides two non-inverting buffer/line drivers with 3-state output. The 3-state output is controlled by the output enable input (pin \overline{OE}). A HIGH level at pin \overline{OE} causes the output to assume a high-impedance OFF-state.

The bus driver output currents are equal compared to the 74HC125 and 74HCT125.

2. Features

- Wide supply voltage range from 2.0 V to 6.0 V
- Symmetrical output impedance
- High noise immunity
- Low power consumption
- Balanced propagation delays
- ESD protection:
 - ◆ HBM EIA/JESD22-A114-C exceeds 2000 V
 - ◆ MM EIA/JESD22-A115-A exceeds 200 V
- Very small 8 pins packages
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ and $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$

3. Quick reference data

Table 1: Quick reference data

$GND = 0\text{ V}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$; $t_r = t_f = 6\text{ ns}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------|----------------------------------|--|-----|-----|-----|------|
| 74HC2G125 | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | $C_L = 15\text{ pF}$; $V_{CC} = 5\text{ V}$ | - | 10 | - | ns |
| C_i | input capacitance | | - | 1.0 | - | pF |
| C_o | output capacitance | | - | 1.5 | - | pF |
| C_{PD} | power dissipation capacitance | per buffer; $V_I = GND$ to V_{CC} | [1] | | | |
| | | output enabled | - | 11 | - | pF |
| | | output disabled | - | 1 | - | pF |

PHILIPS

Table 1: Quick reference data ...continued $GND = 0\text{ V}$; $T_{amb} = 25\text{ °C}$; $t_r = t_f = 6\text{ ns}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------|----------------------------------|---|-----|-----|-----|------|
| 74HCT2G125 | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | $C_L = 15\text{ pF}$; $V_{CC} = 5\text{ V}$ | - | 12 | - | ns |
| C_i | input capacitance | | - | 1.0 | - | pF |
| C_o | output capacitance | | - | 1.5 | - | pF |
| C_{PD} | power dissipation capacitance | per buffer; $V_I = GND$ to $(V_{CC} - 1.5\text{ V})$ | | | | |
| | | output enabled | - | 11 | - | pF |
| | | output disabled | - | 1 | - | pF |

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; V_{CC} = supply voltage in V; N = number of inputs switching; $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

4. Ordering information

Table 2: Ordering information

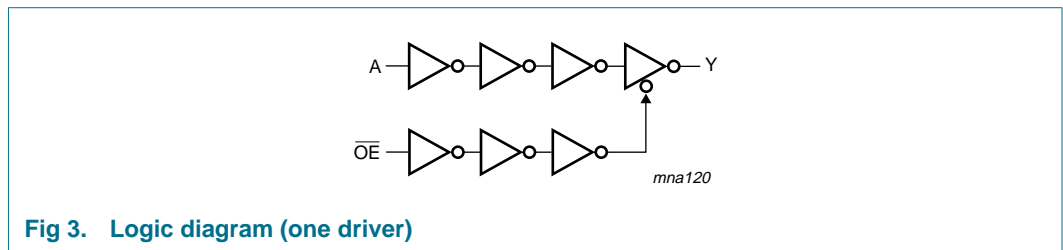
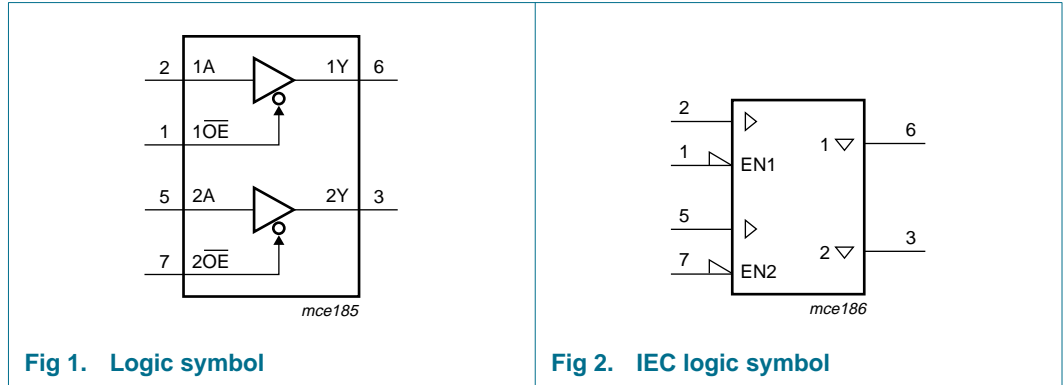
| Type number | Package | | | |
|-------------------|-------------------|--------|--|----------|
| | Temperature range | Name | Description | Version |
| 74HC2G125 | | | | |
| 74HC2G125DP | -40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm | SOT505-2 |
| 74HC2G125DC | -40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |
| 74HCT2G125 | | | | |
| 74HCT2G125DP | -40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm | SOT505-2 |
| 74HCT2G125DC | -40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |

5. Marking

Table 3: Marking

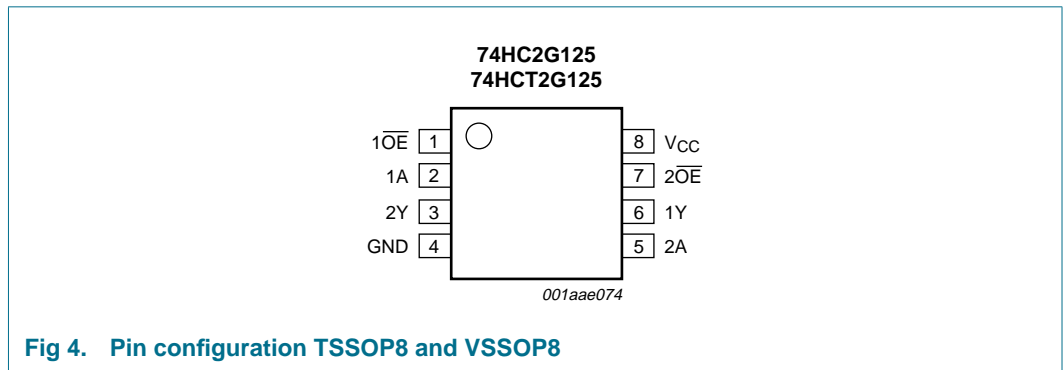
| Type number | Marking code |
|--------------|--------------|
| 74HC2G125DP | H25 |
| 74HC2G125DC | H25 |
| 74HCT2G125DP | T25 |
| 74HCT2G125DC | T25 |

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

Table 4: Pin description

| Symbol | Pin | Description |
|--------|-----|------------------------------------|
| 1OE | 1 | 1 output enable input (active LOW) |
| 1A | 2 | 1 data input A |
| 2Y | 3 | 2 data output Y |
| GND | 4 | ground (0 V) |
| 2A | 5 | 2 data input A |

Table 4: Pin description ...continued

| Symbol | Pin | Description |
|-------------------|-----|------------------------------------|
| 1Y | 6 | 1 data output Y |
| 2 \overline{OE} | 7 | 2 output enable input (active LOW) |
| V _{CC} | 8 | supply voltage |

8. Functional description

8.1 Function table

Table 5: Function table [1]

| Control | Input | Output |
|-------------------|-------|--------|
| n \overline{OE} | nA | nY |
| L | L | L |
| | H | H |
| H | X | Z |

- [1] H = HIGH voltage level;
L = LOW voltage level;
X = don't care;
Z = high-impedance OFF-state.

9. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|--------------------------|--|-------|----------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| I_{IK} | input clamping current | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ | [1] - | ± 20 | mA |
| I_{OK} | output clamping current | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ | [1] - | ± 20 | mA |
| I_O | output current | $V_O = -0.5\text{ V}$ to $(V_{CC} + 0.5\text{ V})$ | [1] - | 35 | mA |
| I_{CC} | quiescent supply current | | - | 70 | mA |
| I_{GND} | ground current | | - | -70 | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$ | [2] - | 300 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 110 °C the value of P_{tot} derates linearly with 8 mW/K.

10. Recommended operating conditions

Table 7: Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------|---------------------------|-------------------------|-----|-----|----------|------|
| 74HC2G125 | | | | | | |
| V_{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | V |
| V_I | input voltage | | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| t_r, t_f | input rise and fall times | $V_{CC} = 2.0\text{ V}$ | - | - | 1000 | ns |
| | | $V_{CC} = 4.5\text{ V}$ | - | 6.0 | 500 | ns |
| | | $V_{CC} = 6.0\text{ V}$ | - | - | 400 | ns |
| 74HCT2G125 | | | | | | |
| V_{CC} | supply voltage | | 4.5 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| t_r, t_f | input rise and fall times | $V_{CC} = 4.5\text{ V}$ | - | 6.0 | 500 | ns |

11. Static characteristics

Table 8: Static characteristics 74HC2G125
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|---------------------------|---|------|------|-----------|---------------|
| $T_{amb} = -40\text{ °C to }+85\text{ °C}$ [1] | | | | | | |
| V_{IH} | HIGH-state input voltage | $V_{CC} = 2.0\text{ V}$ | 1.5 | 1.2 | - | V |
| | | $V_{CC} = 4.5\text{ V}$ | 3.15 | 2.4 | - | V |
| | | $V_{CC} = 6.0\text{ V}$ | 4.2 | 3.2 | - | V |
| V_{IL} | LOW-state input voltage | $V_{CC} = 2.0\text{ V}$ | - | 0.8 | 0.5 | V |
| | | $V_{CC} = 4.5\text{ V}$ | - | 2.1 | 1.35 | V |
| | | $V_{CC} = 6.0\text{ V}$ | - | 2.8 | 1.8 | V |
| V_{OH} | HIGH-state output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -20\text{ }\mu\text{A}; V_{CC} = 2.0\text{ V}$ | 1.9 | 2.0 | - | V |
| | | $I_O = -20\text{ }\mu\text{A}; V_{CC} = 4.5\text{ V}$ | 4.4 | 4.5 | - | V |
| | | $I_O = -20\text{ }\mu\text{A}; V_{CC} = 6.0\text{ V}$ | 5.9 | 6.0 | - | V |
| | | $I_O = -6.0\text{ mA}; V_{CC} = 4.5\text{ V}$ | 3.84 | 4.32 | - | V |
| | | $I_O = -7.8\text{ mA}; V_{CC} = 6.0\text{ V}$ | 5.34 | 5.81 | - | V |
| V_{OL} | LOW-state output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 20\text{ }\mu\text{A}; V_{CC} = 2.0\text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 20\text{ }\mu\text{A}; V_{CC} = 4.5\text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 20\text{ }\mu\text{A}; V_{CC} = 6.0\text{ V}$ | - | 0 | 0.1 | V |
| | | $I_O = 6.0\text{ mA}; V_{CC} = 4.5\text{ V}$ | - | 0.15 | 0.33 | V |
| | | $I_O = 7.8\text{ mA}; V_{CC} = 6.0\text{ V}$ | - | 0.16 | 0.33 | V |
| I_{LI} | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0\text{ V}$ | - | - | ± 1.0 | μA |
| I_{OZ} | OFF-state output current | $V_I = V_{IH}$ or $V_{IL}; V_O = V_{CC}$ or GND; $V_{CC} = 6.0\text{ V}$ | - | - | ± 5.0 | μA |
| I_{CC} | quiescent supply current | $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}; V_{CC} = 6.0\text{ V}$ | - | - | 10 | μA |
| C_i | input capacitance | | - | 1.0 | - | pF |
| C_o | output capacitance | | - | 1.5 | - | pF |
| $T_{amb} = -40\text{ °C to }+125\text{ °C}$ | | | | | | |
| V_{IH} | HIGH-state input voltage | $V_{CC} = 2.0\text{ V}$ | 1.5 | - | - | V |
| | | $V_{CC} = 4.5\text{ V}$ | 3.15 | - | - | V |
| | | $V_{CC} = 6.0\text{ V}$ | 4.2 | - | - | V |
| V_{IL} | LOW-state input voltage | $V_{CC} = 2.0\text{ V}$ | - | - | 0.5 | V |
| | | $V_{CC} = 4.5\text{ V}$ | - | - | 1.35 | V |
| | | $V_{CC} = 6.0\text{ V}$ | - | - | 1.8 | V |
| V_{OH} | HIGH-state output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -20\text{ }\mu\text{A}; V_{CC} = 2.0\text{ V}$ | 1.9 | - | - | V |
| | | $I_O = -20\text{ }\mu\text{A}; V_{CC} = 4.5\text{ V}$ | 4.4 | - | - | V |
| | | $I_O = -20\text{ }\mu\text{A}; V_{CC} = 6.0\text{ V}$ | 5.9 | - | - | V |
| | | $I_O = -6.0\text{ mA}; V_{CC} = 4.5\text{ V}$ | 3.7 | - | - | V |
| | | $I_O = -7.8\text{ mA}; V_{CC} = 6.0\text{ V}$ | 5.2 | - | - | V |

Table 8: Static characteristics 74HC2G125 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------------|--------------------------|--|-----|-----|-------|------|
| V _{OL} | LOW-state output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 20 μA; V _{CC} = 2.0 V | - | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 4.5 V | - | - | 0.1 | V |
| | | I _O = 20 μA; V _{CC} = 6.0 V | - | - | 0.1 | V |
| | | I _O = 6.0 mA; V _{CC} = 4.5 V | - | - | 0.4 | V |
| | | I _O = 7.8 mA; V _{CC} = 6.0 V | - | - | 0.4 | V |
| I _{LI} | input leakage current | V _I = V _{CC} or GND; V _{CC} = 6.0 V | - | - | ±1.0 | μA |
| I _{OZ} | OFF-state output current | V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND; V _{CC} = 6.0 V | - | - | ±10.0 | μA |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V | - | - | 20 | μA |

[1] All typical values are measured at T_{amb} = 25 °C.

Table 9: Static characteristics 74HCT2G125

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|-------------------------------------|--|------|------|------|------|
| T_{amb} = -40 °C to +85 °C [1] | | | | | | |
| V _{IH} | HIGH-state input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | 1.6 | - | V |
| V _{IL} | LOW-state input voltage | V _{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | V |
| V _{OH} | HIGH-state output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | |
| | | I _O = -20 μA | 4.4 | 4.5 | - | V |
| | | I _O = -6.0 mA | 3.84 | 4.32 | - | V |
| V _{OL} | LOW-state output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | |
| | | I _O = 20 μA | - | 0 | 0.1 | V |
| | | I _O = 6.0 mA | - | 0.16 | 0.33 | V |
| I _{LI} | input leakage current | V _I = V _{CC} or GND; V _{CC} = 5.5 V | - | - | ±1.0 | μA |
| I _{OZ} | OFF-state output current | V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND; V _{CC} = 5.5 V | - | - | ±5 | μA |
| I _{CC} | quiescent supply current | V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V | - | - | 10 | μA |
| ΔI _{CC} | additional quiescent supply current | V _I = V _{CC} - 2.1 V; I _O = 0 A; V _{CC} = 4.5 V to 5.5 V | - | - | 375 | μA |
| C _i | input capacitance | | - | 1.0 | - | pF |
| C _o | output capacitance | | - | 1.5 | - | pF |
| T_{amb} = -40 °C to +125 °C | | | | | | |
| V _{IH} | HIGH-state input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-state input voltage | V _{CC} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| V _{OH} | HIGH-state output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | |
| | | I _O = -20 μA | 4.4 | - | - | V |
| | | I _O = -6.0 mA | 3.7 | - | - | V |
| V _{OL} | LOW-state output voltage | V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V | | | | |
| | | I _O = 20 μA | - | - | 0.1 | V |
| | | I _O = 6.0 mA | - | - | 0.4 | V |

Table 9: Static characteristics 74HCT2G125 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------------|-------------------------------------|---|-----|-----|------------|---------|
| I_{LI} | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V | - | - | ± 1.0 | μ A |
| I_{OZ} | OFF-state output current | $V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5$ V | - | - | ± 10.0 | μ A |
| I_{CC} | quiescent supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V | - | - | 20 | μ A |
| ΔI_{CC} | additional quiescent supply current | $V_I = V_{CC} - 2.1$ V; $I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V | - | - | 410 | μ A |

[1] All typical values are measured at $T_{amb} = 25$ °C.

12. Dynamic characteristics

Table 10: Dynamic characteristics 74HC2G125Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--|-------------------------------------|-----|-----|-----|------|
| $T_{amb} = -40$ °C to $+85$ °C [1] | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 | | | | |
| | | $V_{CC} = 2.0$ V | - | 35 | 115 | ns |
| | | $V_{CC} = 4.5$ V | - | 11 | 23 | ns |
| | | $V_{CC} = 5.0$ V; $C_L = 15$ pF | - | 10 | - | ns |
| | | $V_{CC} = 6.0$ V | - | 8 | 20 | ns |
| t_{PZH} , t_{PZL} | 3-state output enable time nOE to nY | see Figure 6 | | | | |
| | | $V_{CC} = 2.0$ V | - | 40 | 115 | ns |
| | | $V_{CC} = 4.5$ V | - | 11 | 23 | ns |
| | | $V_{CC} = 6.0$ V | - | 8 | 20 | ns |
| t_{PHZ} , t_{PLZ} | 3-state output disable time nOE to nY | see Figure 6 | | | | |
| | | $V_{CC} = 2.0$ V | - | 24 | 125 | ns |
| | | $V_{CC} = 4.5$ V | - | 12 | 25 | ns |
| | | $V_{CC} = 6.0$ V | - | 10 | 21 | ns |
| t_{THL} , t_{TLH} | output transition time | see Figure 5 | | | | |
| | | $V_{CC} = 2.0$ V | - | 18 | 75 | ns |
| | | $V_{CC} = 4.5$ V | - | 6 | 15 | ns |
| | | $V_{CC} = 6.0$ V | - | 5 | 13 | ns |
| C_{PD} | power dissipation capacitance | per buffer; $V_I =$ GND to V_{CC} | | | | |
| | | output enabled | [2] | 11 | - | pF |
| | | output disabled | - | 1 | - | pF |

Table 10: Dynamic characteristics 74HC2G125 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|--|------------------------------|-----|-----|-----|------|
| $T_{amb} = -40$ °C to $+125$ °C | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 | | | | |
| | | $V_{CC} = 2.0$ V | - | - | 135 | ns |
| | | $V_{CC} = 4.5$ V | - | - | 27 | ns |
| | | $V_{CC} = 6.0$ V | - | - | 23 | ns |
| t_{PZH} , t_{PZL} | 3-state output enable time nOE to nY | see Figure 6 | | | | |
| | | $V_{CC} = 2.0$ V | - | - | 135 | ns |
| | | $V_{CC} = 4.5$ V | - | - | 27 | ns |
| | | $V_{CC} = 6.0$ V | - | - | 23 | ns |
| t_{PHZ} , t_{PLZ} | 3-state output disable time nOE to nY | see Figure 6 | | | | |
| | | $V_{CC} = 2.0$ V | - | - | 150 | ns |
| | | $V_{CC} = 4.5$ V | - | - | 30 | ns |
| | | $V_{CC} = 6.0$ V | - | - | 26 | ns |
| t_{THL} , t_{TLH} | output transition time | see Figure 5 | | | | |
| | | $V_{CC} = 2.0$ V | - | - | 90 | ns |
| | | $V_{CC} = 4.5$ V | - | - | 18 | ns |
| | | $V_{CC} = 6.0$ V | - | - | 15 | ns |

- [1] All typical values are measured at $T_{amb} = 25$ °C.
- [2] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz;
 f_o = output frequency in MHz;
 C_L = output load capacitance in pF;
 V_{CC} = supply voltage in V;
 N = number of inputs switching;
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Table 11: Dynamic characteristics 74HCT2G125

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--|---|-----|-----|-----|------|
| $T_{amb} = -40$ °C to $+85$ °C [1] | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 | | | | |
| | | $V_{CC} = 4.5$ V | - | 15 | 31 | ns |
| | | $V_{CC} = 5.0$ V; $C_L = 15$ pF | - | 12 | - | ns |
| t_{PZH} , t_{PZL} | 3-state output enable time nOE to nY | see Figure 6 ; $V_{CC} = 4.5$ V | - | 15 | 35 | ns |
| t_{PHZ} , t_{PLZ} | 3-state output disable time nOE to nY | see Figure 6 ; $V_{CC} = 4.5$ V | - | 15 | 31 | ns |
| t_{THL} , t_{TLH} | output transition time | see Figure 5 ; $V_{CC} = 4.5$ V | - | 6 | 15 | ns |

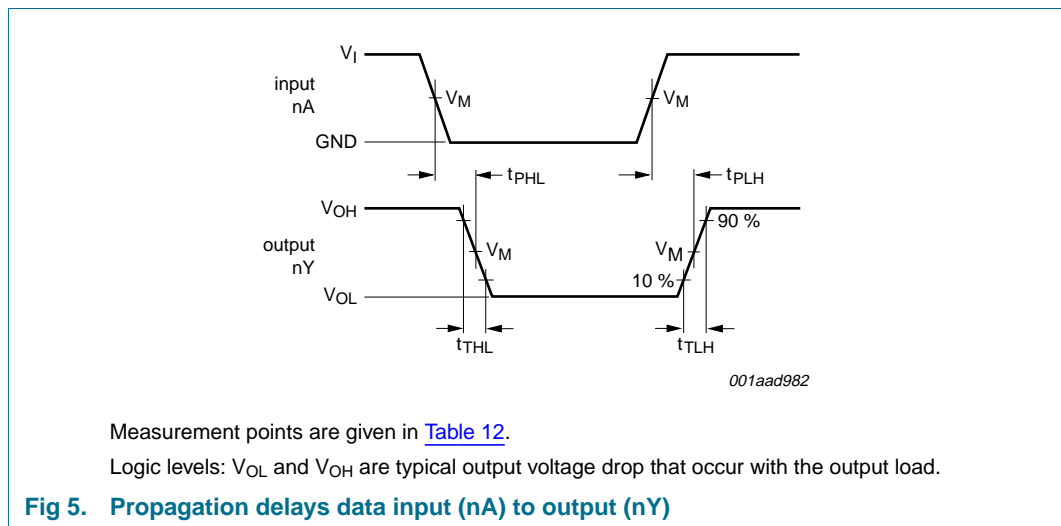
Table 11: Dynamic characteristics 74HCT2G125 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|--|---|-----|-----|-----|------|
| C_{PD} | power dissipation capacitance | per buffer; $V_I = \text{GND to } (V_{CC} - 1.5 \text{ V})$ | [2] | | | |
| | | output enabled | - | 11 | - | pF |
| | | output disabled | - | 1 | - | pF |
| $T_{amb} = -40 \text{ }^\circ\text{C to } +125 \text{ }^\circ\text{C}$ | | | | | | |
| t_{PHL} , t_{PLH} | propagation delay nA to nY | see Figure 5 ; $V_{CC} = 4.5 \text{ V}$ | - | - | 38 | ns |
| t_{PZH} , t_{PZL} | 3-state output enable time nOE to nY | see Figure 6 ; $V_{CC} = 4.5 \text{ V}$ | - | - | 42 | ns |
| t_{PHZ} , t_{PLZ} | 3-state output disable time nOE to nY | see Figure 6 ; $V_{CC} = 4.5 \text{ V}$ | - | - | 38 | ns |
| t_{THL} , t_{TLH} | output transition time | see Figure 5 ; $V_{CC} = 4.5 \text{ V}$ | - | - | 18 | ns |

- [1] All typical values are measured at $T_{amb} = 25 \text{ }^\circ\text{C}$.
- [2] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz;
 f_o = output frequency in MHz;
 C_L = output load capacitance in pF;
 V_{CC} = supply voltage in V;
 N = number of inputs switching;
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

13. Waveforms



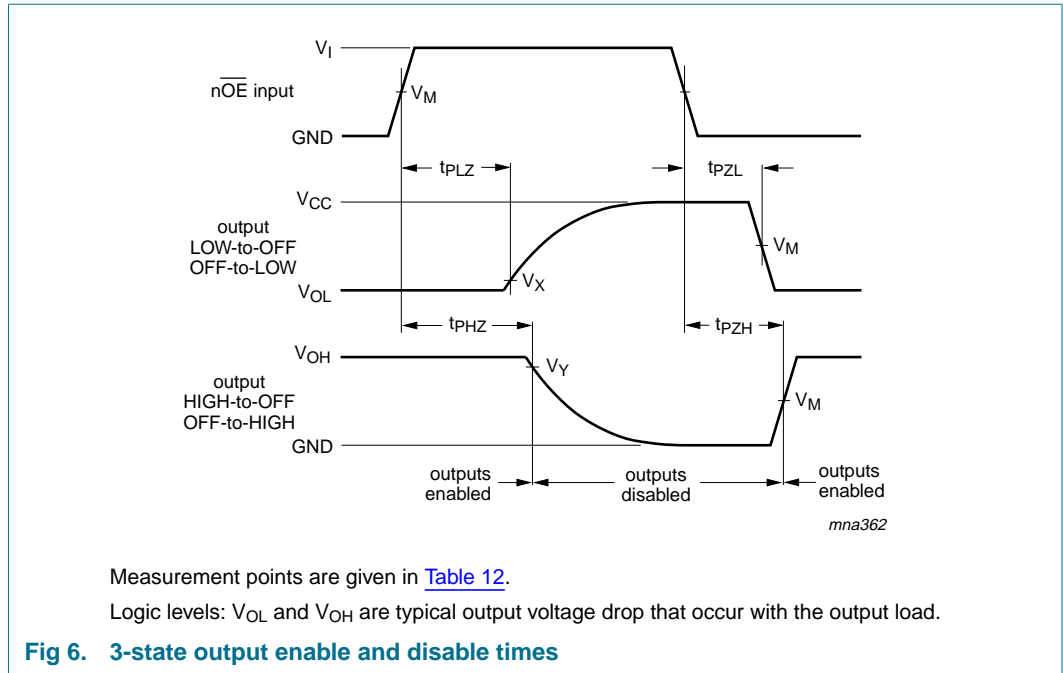


Table 12: Measurement points

| Type | Input | Output | | |
|------------|-------------|-------------|-------------------------|-------------------------|
| | V_M | V_M | V_X | V_Y |
| 74HC2G125 | $0.5V_{CC}$ | $0.5V_{CC}$ | $V_{OL} + 0.3\text{ V}$ | $V_{OH} - 0.3\text{ V}$ |
| 74HCT2G125 | 1.3 V | 1.3 V | $V_{OL} + 0.3\text{ V}$ | $V_{OH} - 0.3\text{ V}$ |

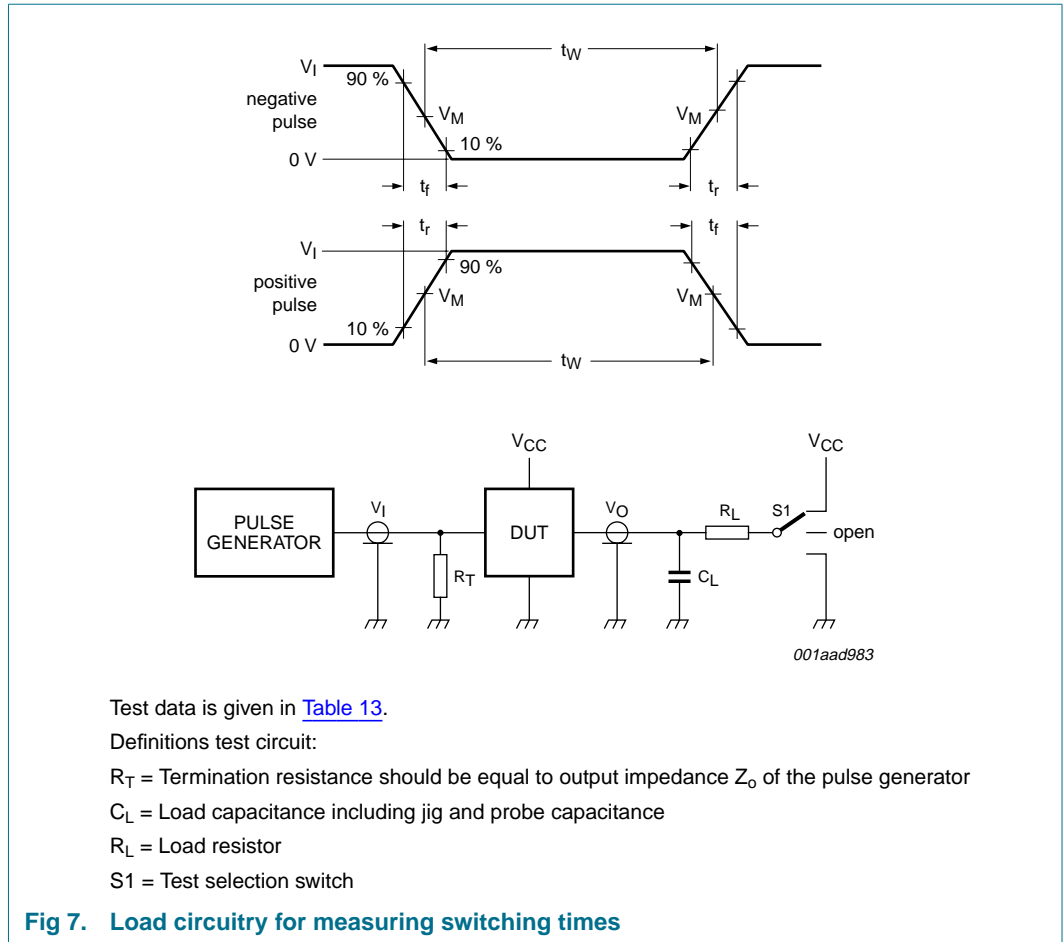


Table 13: Test data

| Type | Input | | Load | | S1 position | | |
|------------|----------|------------|--------------|--------------|--------------------|--------------------|--------------------|
| | V_I | t_r, t_f | C_L | R_L | t_{PHL}, t_{PLH} | t_{PZH}, t_{PHZ} | t_{PZL}, t_{PLZ} |
| 74HC2G125 | V_{CC} | 6 ns | 15 pF, 50 pF | 1 k Ω | open | GND | V_{CC} |
| 74HCT2G125 | 3 V | 6 ns | 15 pF, 50 pF | 1 k Ω | open | GND | V_{CC} |

14. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

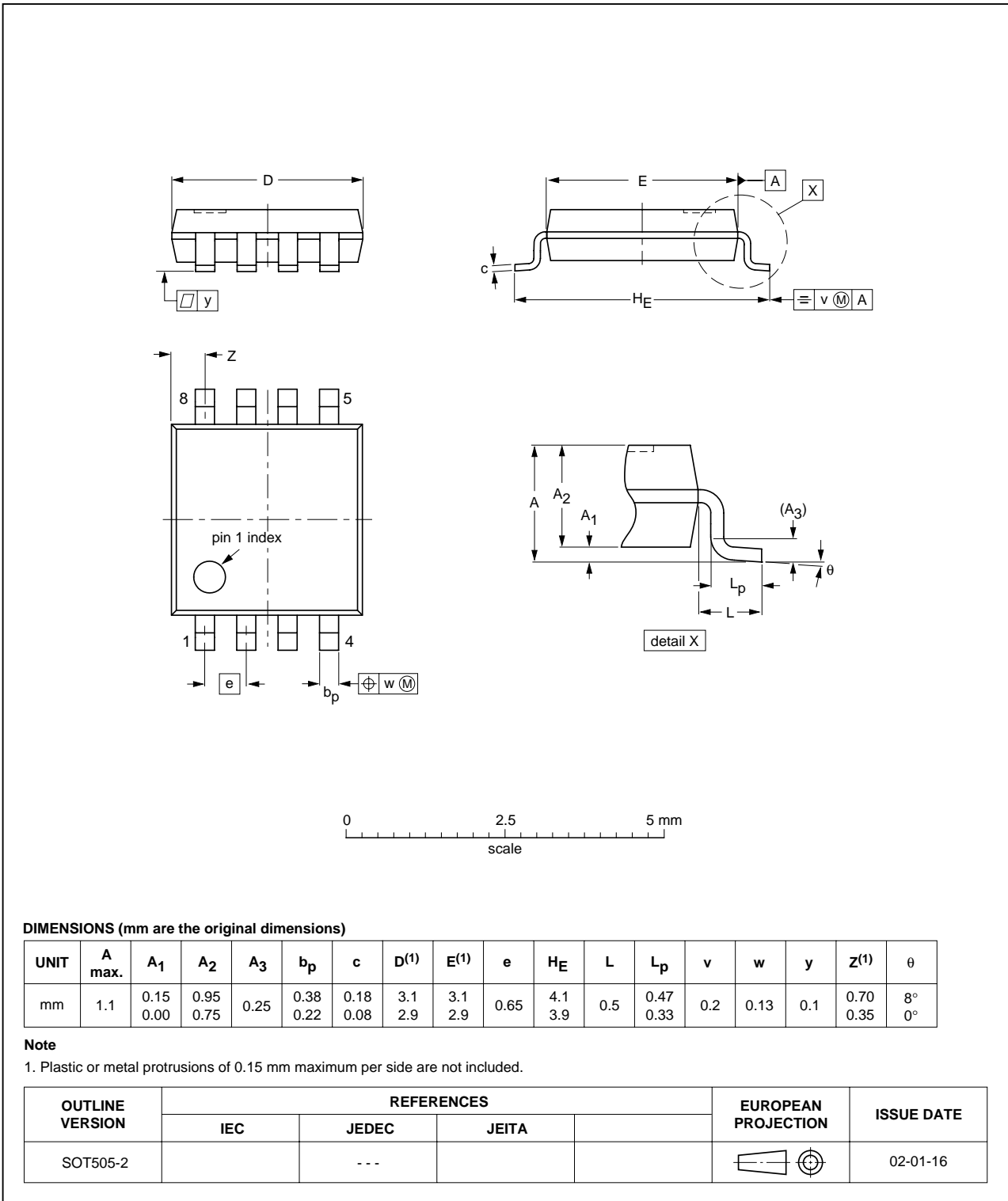


Fig 8. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

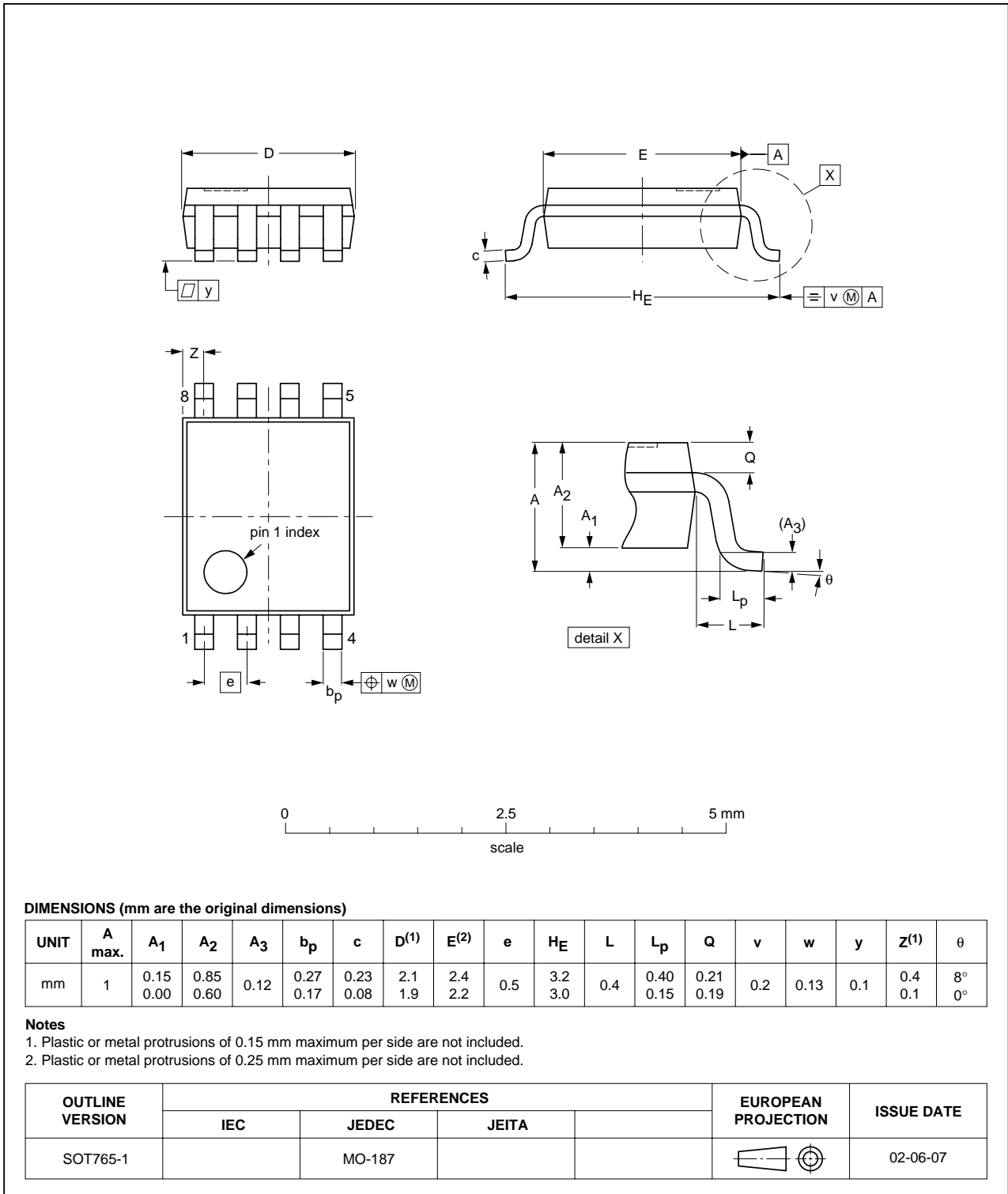


Fig 9. Package outline SOT765-1 (VSSOP8)

15. Abbreviations

Table 14: Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |

16. Revision history

Table 15: Revision history

| Document ID | Release date | Data sheet status | Change notice | Doc. number | Supersedes |
|---|--------------|-----------------------|---------------|----------------|-----------------|
| 74HC_HCT2G125_3 | 20060102 | Product data sheet | - | - | 74HC_HCT2G125_2 |
| Modifications: <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors. • Table 6: <ul style="list-style-type: none"> – Changed I_O max value from 25 to 35 – Changed I_{CC} and I_{GND} max value from 50 to 70 • Table 8; $T_{amb} = -40\text{ °C}$ to $+85\text{ °C}$: <ul style="list-style-type: none"> – Changed V_{OH} min value at $I_O = -6.0\text{ mA}$ and $V_{CC} = 4.5\text{ V}$ from 4.13 in 3.84 – Changed V_{OH} min value at $I_O = -7.8\text{ mA}$ and $V_{CC} = 6.0\text{ V}$ from 5.63 in 5.34 • Table 8; $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$: <ul style="list-style-type: none"> – Changed I_{OZ} max value from 10.4 in 10.0 • Table 9; $T_{amb} = -40\text{ °C}$ to $+85\text{ °C}$: <ul style="list-style-type: none"> – Changed V_{OH} min value at $I_O = -6.0\text{ mA}$ and $V_{CC} = 4.5\text{ V}$ from 4.13 in 3.84 – Changed V_{OL} min value at $I_O = 6.0\text{ mA}$ and $V_{CC} = 4.5\text{ V}$ from 0.15 in 0.16 • Table 9; $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$: <ul style="list-style-type: none"> – Changed I_{OZ} max value from 10.4 in 10.0 | | | | | |
| 74HC_HCT2G125_2 | 030303 | Product specification | - | 9397 750 11068 | 74HC_HCT2G125_1 |
| 74HC_HCT2G125_1 | 030131 | Product specification | - | 9397 750 10641 | - |

17. Data sheet status

| Level | Data sheet status ^[1] | Product status ^[2] ^[3] | Definition |
|-------|----------------------------------|--|--|
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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